intersi

DATASHEET

ISL72026SEH

3.3V Radiation Tolerant CAN Transceiver with Listen Mode and Loopback

FN8762 Rev 3.00 August 16, 2016

The Intersil ISL72026SEH is a radiation tolerant 3.3V CAN transceiver that is compatible with the ISO11898-2 standard for applications calling for Controller Area Network (CAN) serial communication in satellites and aerospace communications and telemetry data processing in harsh industrial environments.

The transceiver can transmit and receive at bus speeds up to 5Mbps. It can drive a 40m cable at 1Mbps per the ISO11898-2 specification. The device is designed to operate over a common-mode range of -7V to +12V with a maximum of 120 nodes. The device has three discrete selectable driver rise/fall time options, a listen mode feature and loopback test capability.

Receiver (Rx) inputs feature a "full fail-safe" design, which ensures a logic high Rx output if the Rx inputs are floating. shorted, or terminated but undriven.

The ISL72026SEH is available in an 8 Ld hermetic ceramic flatpack and die form that operate across the temperature range of -55°C to +125°C. The logic inputs are tolerant with 5V systems.

Other CAN transceivers available are the ISL72027SEH and ISL72028SEH. For a list of differences see Table 1 on page 2.

Related Literature

- UG051, "ISL7202xSEHEVAL1Z Evaluation Board User Guide"
- TR018, "SEE Testing of the ISL72027SEH CAN Transceiver"
- TR022, "Total Dose Testing of the ISL72026SEH, ISL72027SEH and ISL72028SEH CAN Transceivers"

Features

- Electrically screened to SMD <u>5962-15228</u>
- ESD protection on all pins.....4kV HBM
- Compatible with IS011898-2
- Bus pin fault protection to ±20V
- Undervoltage lockout
- Cold spare: powered down devices/nodes will not affect active devices operating in parallel
- · Three selectable driver rise and fall times
- · Glitch free bus I/O during power-up and power-down
- Full fail-safe (open, short, terminated/undriven) receiver
- · Hi Z input allows for 120 nodes on the bus
- High data rates..... up to 5Mbps

- -7V to +12V common mode input voltage range
- 5V tolerant logic inputs
- Thermal shutdown
- · Acceptance tested to 75krad(Si) (LDR) wafer-by-wafer
- Radiation tolerance
 - SEL/B immune to LET 60MeV·cm²/mg
 - Low dose rate (0.01rad(Si)/s) 75krad(Si)

Applications

- · Satellites and aerospace communications
- Telemetry data processing
- · High-end industrial environments
- · Harsh environments

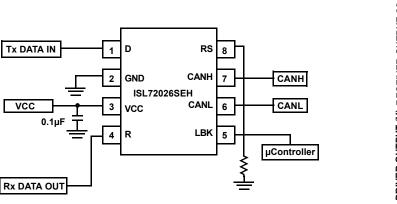


FIGURE 1. TYPICAL APPLICATION

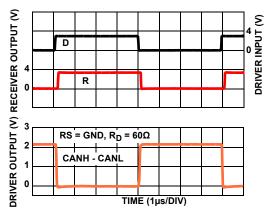


FIGURE 2. FAST DRIVER AND RECEIVER WAVEFORMS

VCC

Ordering Information

ORDERING / SMD NUMBER (<u>Note 1</u>)	PART NUMBER (Note 2)	TEMPERATURE RANGE (°C)	PACKAGE (RoHS Compliant)	PACKAGE DRAWING #
5962L1522801VXC	ISL72026SEHVF	-55 to +125	8 Ld Ceramic Flat Pack	K8.A
N/A	ISL72026SEHF/PROTO	-55 to +125	8 Ld Ceramic Flat Pack	K8.A
5962L1522801V9A	ISL72026SEHVX	-55 to +125	Die	
N/A	ISL72026SEHX/SAMPLE	-55 to +125	Die	
N/A	ISL72026SEHEVAL1Z		Evaluation Board	

NOTES:

1. Specifications for Radiation Tolerant QML devices are controlled by the Defense Logistics Agency Land and Maritime (DLA). The SMD numbers listed in the "Ordering Information" table must be used when ordering.

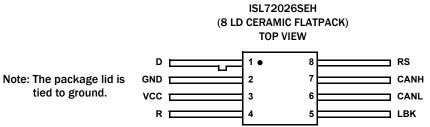
2. These Intersil Pb-free Hermetic packaged products employ 100% Au plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations.

SPEC	ISL72026SEH	ISL72027SEH	ISL72028SEH		
Loopback Feature	Yes	No	No		
VREF Output	No	Yes	Yes		
Listen Mode	Yes	Yes	No		
Shutdown Mode	No	No	Yes		
VTHRLM	1150mV (Max)	1150mV (Max)	N/A		
VTHFLM	525mV (Min)	525mV (Min)	N/A		
VHYSLM	50mV (Min)	50mV (Min)	N/A		
Supply Current, Listen Mode	2mA (Max)	2mA (Max)	N/A		
Supply Current, Shutdown Mode	N/A	N/A	50µA (Max)		
VREF Leakage Current	N/A	±25µA (Max)	±25µA (Max)		

TABLE 1. ISL7202xSEH PRODUCT FAMILY FEATURE TABLE

N/A: Not Applicable

Pin Configuration

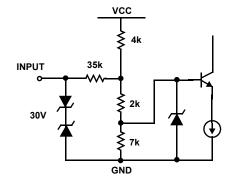


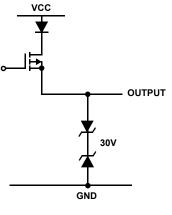
Pin Descriptions

PIN NUMBER	PIN NAME	FUNCTION
1	D	CAN driver digital input. The bus states are LOW = Dominant and HIGH = Recessive. Internally tied HIGH.
2	GND	Ground connection.
3	VCC	System power supply input (3.0V to 3.6V). The typical voltage for the device is 3.3V.
4	R	CAN Data Receiver Output. The bus states are LOW = Dominant and HIGH = Recessive.
8	RS	A resistor to GND from this pin controls the rise and fall time of the CAN output waveform. Drive RS HIGH to put into Listen Mode.
6	CANL	CAN bus line for low level output
7	CANH	CAN bus line for high level output
5	LBK	A HIGH on this pin places CANH and CANL pins in a high impedance state. The rest of the circuit remains active so that the TX and RX can loopback diagnostic information. Internally tied LOW.



Equivalent Input and Output Schematic Diagrams





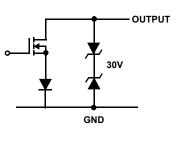
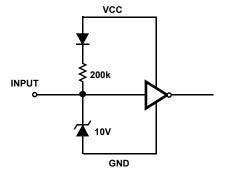
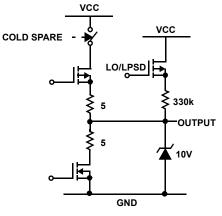


FIGURE 3. CANH AND CANL INPUTS

FIGURE 4. CANH OUTPUT

FIGURE 5. CANL OUTPUT





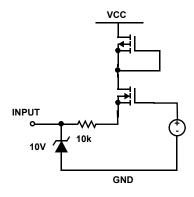
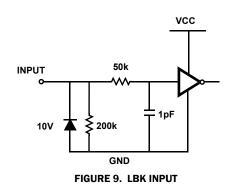


FIGURE 6. D INPUT

FIGURE 7. R OUTPUT

FIGURE 8. RS INPUT



Absolute Maximum Ratings

VCC to GND with/without Ion Beam
CANH, CANL, VREF Under Ion Beam±18V
CANH, CANL, VREF
I/O Voltages
D, R, RS0.5V to 7V
Receiver Output Current
Output Short-Circuit Duration Continuous
ESD Rating:
Human Body Model (Tested per MIL-PRF-883 3015.7)
CANH, CANL Bus Pins 4kV
All Other Pins 4kV
Charged Device Model (Tested per JESD22-C101D)750V
Machine Model (Tested per JESD22-A115-A)

Thermal Information

Thermal Resistance (Typical)	$ heta_{JA}$ (° C/W).	θ _{JC} (°C/W)
8 Ld FP Package (Notes 3, 4) Direct Attach .	39	7
Maximum Junction Temperature		+175°C
Storage Temperature Range		°C to +150 °C

Operating Conditions

Temperature Range	55°C to +125°C
V _{CC} Supply Voltage	3.0V to 3.6V
Voltage on CAN I/O	7V to 12V
V _{IH} D Logic Pins (D, LBK)	
V _{IL} D Logic Pins (D, LBK)	0V to 0.8V
I _{OH} Driver (CANH - CANL = 1.5V, V _{CC} = 3.3V)	40mA
I _{OH} Receiver (V _{OH} = 2.4V)	4mA
I _{OL} Driver (CANH - CANL = 1.5V, V _{CC} = 3.3V)	+40mA
I _{OL} Receiver (V _{OL} = 0.4V)	+4mA

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

- θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board (two buried 1oz copper planes) with "direct attach" features (package base mounted to PCB thermal land with a 10 mil gap fill material having a k of 1W/m-K. See Tech Brief <u>TB379</u>.
- 4. For θ_{JC} the "case temp" location is the center of the package underside.

Electrical Specifications Test Conditions: VCC = 3.0V to 3.6V; Typicals are at $T_A = +25$ °C (<u>Note 7</u>); unless otherwise specified (<u>Note 5</u>). Boldface limits apply across the operating temperature range, -55°C to +125°C or over a total lonizing dose of 75krad(SI) at +25°C with exposure at a low dose rate of <10mrad(SI)/s.

PARAMETER	SYMBOL	TEST CONDIT	IONS	TEMP (°C)	MIN (<u>Note 6</u>)	TYP (<u>Note 7</u>)	MAX (<u>Note 6</u>)	UNIT
DRIVER ELECTRICAL CHARACTER	ISTICS							
Dominant Bus Output Voltage	V _{O(DOM)}	D = 0V, CANH, RS = 0V, Figures 10 and <u>11</u>	$3.0V \le V_{CC} \le 3.6V$	Full	2.25	2.85	v _{cc}	v
		D = 0V, CANL, RS = 0V, Figures 10 and <u>11</u>		Full	0.1	0.65	1.25	v
Recessive Bus Output Voltage	V _{O(REC)}	D = 3V, CANH, RS = 0V, 60Ω and no load, <u>Figures 10</u> and 11	3.0V≤ V _{CC} ≤ 3.6V	Full	1.80	2.3	2.70	v
		D = 3V, CANL, RS = 0V, 60Ω and no load, <u>Figures 10</u> and <u>11</u>		Full	1.80	2.3	2.80	v
Dominant Output Differential Voltage	V _{OD(DOM)}	D = 0V, RS = 0V, $3.0V \le V_{CC} \le \frac{11}{1}$	3.6V, Figures 10 and	Full	1.5	2.2	3	v
		D = 0V, RS = 0V, $3.0V \le V_{CC} \le \frac{12}{12}$	3.6V, Figures 11 and	Full	1.2	2.1	3	v
Recessive Output Differential Voltage	V _{OD(REC)}	D=3V, RS = 0V, $3.0V \le V_{CC} \le \frac{11}{1}$	3.6V, <u>Figures 10</u> and	Full	-120	0.2	12	mV
		D = 3V, RS = 0V, $3.0V \le V_{CC} \le$	3.6V, no load	Full	-500	-34	50	mV
Logic Input High Voltage (D, LBK)	V _{IH}	3.0V ≤ V _{CC} ≤ 3.6V, <u>Note 8</u>		Full	2.0	-	5.5	v
Logic Input Low Voltage (D, LBK)	V _{IL}	3.0V ≤ V _{CC} ≤ 3.6V, <u>Note 8</u>		Full	0	-	0.8	٧
Logic High Level Input Current (D, LBK)	Iн	$D = 2.0V, 3.0V \le V_{CC} \le 3.6V, I$	Note 9	Full	-30	-3	30	μA
Logic Low Level Input Current (D, LBK)	IIL	$D = 0.8V, 3.0V \le V_{CC} \le 3.6V, 1$	D = 0.8V, 3.0V ≤ V _{CC} ≤ 3.6V, <u>Note 9</u>		-30	-7	30	μA
RS Input Voltage for Listen Mode	V _{IN(RS)}	$3.0V \le V_{CC} \le 3.6V$		Full	0.75 VCC	1.9	5.5	v

Electrical Specifications Test Conditions: VCC = 3.0V to 3.6V; Typicals are at $T_A = +25$ °C (<u>Note 7</u>); unless otherwise specified (<u>Note 5</u>). Boldface limits apply across the operating temperature range, -55 °C to +125 °C or over a total lonizing dose of 75krad(Si) at +25 °C with exposure at a low dose rate of <10mrad(SI)/s. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	TEMP (°C)	MIN (<u>Note 6</u>)	TYP (<u>Note 7</u>)	MAX (<u>Note 6</u>)	UNIT
Output Short-Circuit Current	l _{osc}	$V_{CANH} = -7V$, CANL = OPEN, 3.0V $\leq V_{CC} \leq$ 3.6V, Figure 19	Full	-250	-100	-	mA
		V_{CANH} = +12V, CANL = OPEN, 3.0V $\leq V_{CC} \leq$ 3.6V, Figure 19	Full	-	0.4	1	mA
		$V_{CANL} = -7V$, CANH = OPEN, 3.0V $\leq V_{CC} \leq$ 3.6V, Figure 19	Full	-1	-0.4	-	mA
		V_{CANL} = +12V, CANH = OPEN, 3.0V $\leq V_{CC} \leq$ 3.6V, Figure 19	Full	-	100	250	mA
Thermal Shutdown Temperature	T _{SHDN}	3.0V < V _{IN} < 3.6V	-	-	163	-	°C
Thermal Shutdown Hysteresis	T _{HYS}	3.0V < V _{IN} < 3.6V	-	-	12	-	°C
RECEIVER ELECTRICAL CHARACT	ERISTICS						
Input Threshold Voltage (Rising)	V _{THR}	LBK = 0V, RS = 0V, 10k, 50k, (recessive to dominant), Figures 14 and 15	Full	-	750	900	mV
Input Threshold Voltage (Falling)	V _{THF}	LBK = 0V, RS = 0V, 10k, 50k, (dominant to recessive), Figures 14 and 15	Full	500	650	-	mV
Input Hysteresis	V _{HYS}	(V _{THR} - V _{THF}), RS = 0V, 10k, 50k, <u>Figures 14</u> and <u>15</u>	Full	40	90	-	mV
Listen Mode Input Threshold Voltage (Rising)	V _{THRLM}	S = V _{CC} , (recessive to dominant), <u>Figure 14</u> F		-	920	1150	mV
Listen Mode Input Threshold Voltage (Falling)	V _{THFLM}	RS = V _{CC} , (dominant to recessive), <u>Figure 14</u>	Full	525	820	-	mV
Listen Mode Input Hysteresis	V _{HYSLM}	(V _{THR} - V _{THF}), RS = V _{CC} , <u>Figure 14</u>	Full	50	100	-	mV
Receiver Output High Voltage	V _{OH}	I ₀ = -4mA	Full	2.4	V _{CC} - 0.2	-	v
Receiver Output Low Voltage	V _{OL}	l ₀ = +4mA		-	0.2	0.4	v
Input Current for CAN Bus	ICAN	CANH or CANL at 12V, D = 3V, other bus pin at 0V, LBK = RS = 0V	Full	-	420	500	μA
		CANH or CANL at 12V, D = 3V, V_{CC} = 0V, other bus pin at 0V, LBK = RS = 0V	Full	-	150	250	μA
		CANH or CANL at -7V, D = 3V, other bus pin at 0V, LBK = RS = 0V	Full	400	-300	-	μA
		CANH or CANL at -7V,D = 3V, V _{CC} = 0V, other bus pin at 0V, LBK = RS = 0V	Full	150	-85	-	μA
Input Capacitance (CANH or CANL)	C _{IN}	Input to GND, D = 3V, LBK = RS = 0V	25	-	35	-	pF
Differential Input Capacitance	C _{IND}	Input to Input, D = 3V, LBK = RS = 0V	25	-	15	-	pF
Input Resistance (CANH or CANL)	R _{IN}	Input to GND, D = 3V, LBK = RS = 0V	Full	20	40	50	kΩ
Differential Input Resistance	R _{IND}	Input to Input, D = 3V, LBK = RS = 0V	Full	40	80	100	kΩ
SUPPLY CURRENT				r			I.
Supply Current, Listen Mode	I _{CC(L)}	$RS = D = V_{CC}, LBK = OV, 3.0V \le V_{CC} \le 3.6V$	Full	-	1	2	mA
Supply Current, Dominant	I _{CC(DOM)}	D = LBK = RS = 0V, no load, $3.0V \le V_{CC} \le 3.6V$	Full	-	5	7	mA
Supply Current, Recessive	I _{CC(REC)}	D = V _{CC} , LBK = RS = 0V, no load, $3.0V \le V_{CC} \le 3.6V$	Full	-	2.6	5	mA
COLD SPARING BUS CURRENT							
CANH Leakage Current	I _{L(CANH)}	V_{CC} = 0.2V, CANH = -7V or 12V, CANL = float, D = V _{CC} , RS = 0V	Full	-25	-4	25	μA
CANL Leakage Current	I _{L(CANL)}	$V_{CC} = 0.2V$, CANL = -7V or 12V, CANH = float, D = V _{CC} , RS = 0V	Full	-25	-4	25	μA

Electrical Specifications Test Conditions: VCC = 3.0V to 3.6V; Typicals are at $T_A = +25$ °C (<u>Note 7</u>); unless otherwise specified (<u>Note 5</u>). Boldface limits apply across the operating temperature range, -55°C to +125°C or over a total ionizing dose of 75krad(Si) at +25°C with exposure at a low dose rate of <10mrad(SI)/s. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	TEMP (°C)	MIN (<u>Note 6</u>)	TYP (<u>Note 7</u>)	MAX (<u>Note 6</u>)	UNIT
DRIVER SWITCHING CHARACTER	ISTICS						<u> </u>
Propagation Delay LOW to HIGH	tPDLH1	RS = 0V, <u>Figure 13</u>	Full	-	75	150	ns
Propagation Delay LOW to HIGH	t _{PDLH2}	$RS = 10k\Omega, \frac{Figure 13}{10}$	Full	-	520	850	ns
Propagation Delay LOW to HIGH	t _{PDLH3}	RS = $50k\Omega$, Figure 13	Full	-	850	1400	ns
Propagation Delay HIGH to LOW	t _{PDHL1}	RS = 0V, Figure 13	Full	-	80	155	ns
Propagation Delay HIGH to LOW	t _{PDHL2}	RS = 10kΩ, <u>Figure 13</u>	Full	-	460	800	ns
Propagation Delay HIGH to LOW	t _{PDHL3}	RS = $50k\Omega$, <u>Figure 13</u>	Full	-	725	1300	ns
Output Skew	t _{SKEW1}	RS = 0V, (t _{PHL} - t _{PLH}), <u>Figure 13</u>	Full	-	5	50	ns
Output Skew	t _{SKEW2}	RS = 10kΩ, (t _{PHL} - t _{PLH}), <u>Figure 13</u>	Full	-	60	510	ns
Output Skew	t _{skew3}	RS = 50kΩ, (t _{PHL} - t _{PLH}), <u>Figure 13</u>	Full	-	110	800	ns
Output Rise Time	t _{r1}	RS = 0V, (fast speed)	Full	20	55	100	ns
Output Fall Time	t _{f1}	Figure 13	Full	10	25	75	ns
Output Rise Time	t _{r2}	RS = $10k\Omega$, (medium speed - $250kbps$)	Full	200	400	780	ns
Output Fall Time	t _{f2}	Figure 13	Full	175	300	500	ns
Output Rise Time	t _{r3}	RS = $50k\Omega$, (slow speed - 125kbps)	Full	400	700	1400	ns
Output Fall Time	t _{f3}	Figure 13	Full	300	650	1000	ns
Total Loop Delay, Driver Input to	t _{(LOOP1})	RS = 0V, <u>Figure 17</u>	Full	-	115	210	ns
Receiver Output, Recessive to Dominant		RS = $10k\Omega$, Figure 17	Full	-	550	875	ns
Dominant		RS = $50k\Omega$, <u>Figure 17</u>	Full	-	850	1400	ns
Fotal Loop Delay, Driver Input to t _(LOOP2)		RS = 0V, <u>Figure 17</u>	Full	-	130	270	ns
Receiver Output, Dominant to Recessive		RS = $10k\Omega$, Figure 17	Full	-	500	825	ns
Recessive		RS = 50k Ω , <u>Figure 17</u>	Full	-	750	1300	ns
Listen to Valid Dominant Time	t _{L-DOM}	Figure 16	Full	-	5	15	μs
RECEIVER SWITCHING CHARACTI	ERISTICS						
Propagation Delay LOW to HIGH	t _{PLH}	Figure 14	Full	-	50	110	ns
Propagation Delay HIGH to LOW	t _{PHL}	Figure 14	Full	-	50	110	ns
Rx Skew	t _{SKEW1}	(t _{PHL} - t _{PLH}) , <u>Figure 14</u>	Full	-	2	35	ns
Rx Rise Time	t _r	Figure 14	Full	-	2	-	ns
Rx Fall Time	t _f	Figure 14	Full	-	2	-	ns
LBK Delay I/O to Rx Output	t _{LBK}	Figure 18, Note 9	Full	-	35	75	ns
RS PIN CHARACTERISTICS		·					
RS Input Current	I _{RS(H)}	RS = 0.75 x V _{CC}	Full	-10	-0.2	-	μΑ
	I _{RS(L)}	V _{RS} = 0V	Full	-450	-125	0	μA

NOTES:

5. All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

7. Typical values are at 3.3V. Parameters with a single entry in the "TYP" column apply to 3.3V. Typical values shown are not guaranteed.

8. Parameter included in functional testing.

9. Performed during the 100% screening operations over the full operating temperature range. Not performed as part of TCI Group E and Group C. Radiation characterization testing performed as part of the initial release and any major changes in design.

Test Circuits and Waveforms

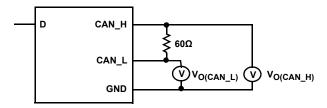


FIGURE 10. DRIVER TEST CIRCUIT

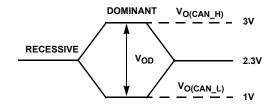
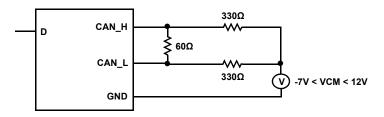
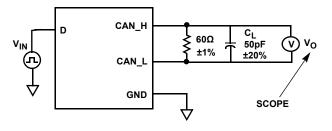
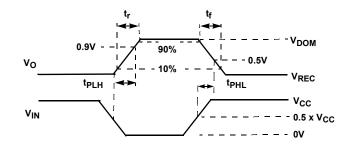


FIGURE 11. DRIVER BUS VOLTAGE DEFINITIONS









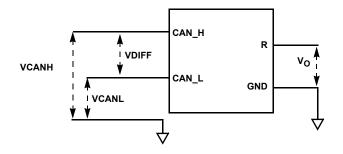
 V_{IN} = 125kHz, 0V to V_{CC} , Duty Cycle 50%, $t_r = t_f \le 6ns$, $Z_O = 50\Omega C_L$ includes fixture and instrumentation capacitance.

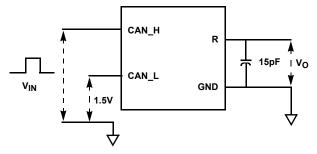
FIGURE 13A. DRIVER TIMING TEST CIRCUIT

FIGURE 13B. DRIVER TIMING MEASUREMENT POINTS

FIGURE 13. DRIVER TIMING

Test Circuits and Waveforms (Continued)





 $V_{\mbox{\rm IN}}$ = 125kHz, Duty Cycle 50%, $t_{\mbox{\rm r}}$ = $t_{\mbox{\rm f}}$ = 6ns, Z_{\mbox{\rm O}} = 50 Ω C_L includes test setup capacitance

FIGURE 14B. RECEIVER TEST CIRCUIT

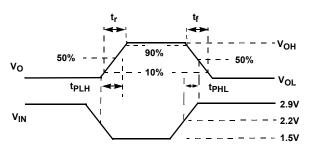


FIGURE 14A. RECEIVER VOLTAGE DEFINITIONS

FIGURE 14C. RECEIVER TEST MEASUREMENT POINTS

		TABLE 2.	
IN	PUT	OUTPUT	MEAS
NH	VCANL	R	VD
1V	-7V	L	900
v	11 11	I	000

FIGURE 14. RECEIVER TEST

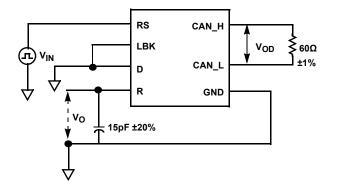
IN	PUT	OUTPUT	MEASURED		
VCANH	VCANL	R	VDIFF		
-6.1V	-7V	L	900mV		
12V	11.1V	L	900mV		
-1V	-7V	L	6V		
12V	6V	L	6V		
-6.5V	-7V	Н	500mV		
12V	11.5V	н	500mV		
-7V	-1V	Н	6V		
6V	12V	н	6V		

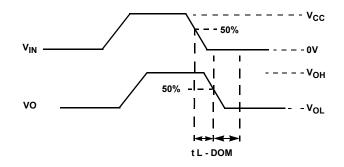
FIGURE 15. DIFFERENTIAL INPUT VOLTAGE THRESHOLD TEST

FN8762 Rev 3.00 August 16, 2016

inter_{sil}[®]

Test Circuits and Waveforms (Continued)

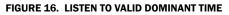




 V_{IN} = 125kHz, 0V to V_{CC} , Duty Cycle 50%, $t_r = t_f \le 6$ ns

FIGURE 16A. LISTEN TO VALID DOMINANT TIME TEST CIRCUIT

FIGURE 16B. LISTEN TO VALID DOMINANT TIME MEASUREMENT POINTS



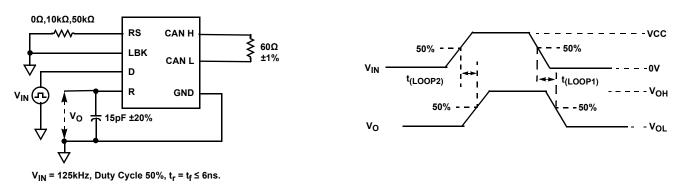
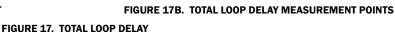
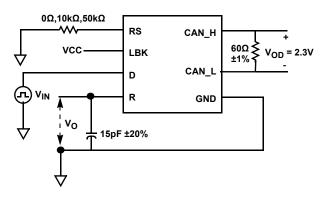


FIGURE 17A. TOTAL LOOP DELAY TEST CIRCUIT





 $V_{\mbox{\rm IN}}$ = 125kHz, 0V to $V_{\mbox{\rm CC}},$ Duty Cycle 50%, $t_{\mbox{\rm r}}$ = $t_{\mbox{\rm f}}$ ≤ 6ns

FIGURE 18A. LOOP BACK DELAY TO DOMINANT TIME TEST CIRCUIT

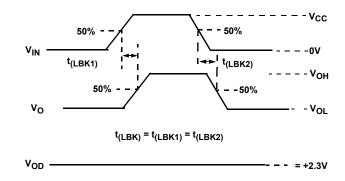
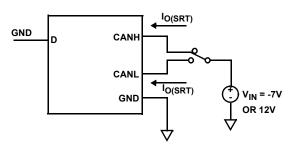


FIGURE 18B. LOOP BACK DELAY TO DOMINANT MEASUREMENT POINTS

FIGURE 18. LOOP BACK DELAY



Test Circuits and Waveforms (continued)



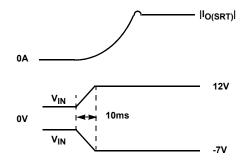


FIGURE 19A. OUTPUT SHORT CIRCUIT CURRENT TEST CIRCUIT

FIGURE 19B. OUTPUT SHORT CIRCUIT CURRENT WAVEFORMS

FIGURE 19. OUTPUT SHORT CIRCUIT CURRENT

Functional Description

Overview

The Intersil ISL72026SEH is a 3.3V radiation tolerant CAN transceiver that is compatible with the ISO11898-2 standard for use in CAN (Controller Area Network) serial communication systems.

The device performs transmit and receive functions between the CAN controller and the CAN differential bus. It can transmit and receive at bus speeds of up to 5Mbps. It is designed to operate over a common mode range of -7V to +12V with a maximum of 120 nodes. The device is capable of withstanding ±20V on the CANH and CANL bus pins outside of ion beam and ±16V under ion beam.

Slope Adjustment

The output driver rise and fall time has three distinct selections that may be chosen by using a resistor from the RS pin to GND. Connecting the RS pin directly to GND results in output switching times that are the fastest, limited only by the drive capability of the output stage. RS = $10k\Omega$ provides for a typical slew rate of $8V/\mu s$ and RS = $50k\Omega$ provides for a typical slew rate of $4V/\mu s$.

Putting a high logic level to the RS pin places the device in a low current listen mode. The protocol controller uses this mode to switch between low power listen mode and normal transmit mode.

Cable Length

The device can work per ISO11898 specification with a 40m cable and stub length of 0.3m and 60 nodes at 1Mbps. This is greater than the ISO requirement of 30 nodes. The cable type specified is twisted pair (shielded or unshielded) with a characteristic impedance of 120 Ω . Resistors equal to this are to be terminated at both ends of the cable. Stubs should be kept as short as possible to prevent reflections.

Cold Spare

High reliability system designers implementing data communications have to be sensitive to the potential for single point failures. To mitigate the risk of a failure they will use redundant bus transceivers in parallel. In this arrangement both active and quiescent devices can be present simultaneously on the bus. The quiescent devices are powered down for cold spare and do not affect the communication of the other active nodes.

To achieve this, a powered down transceiver (V_{CC} < 200mV) has a resistance between the CANH or CANL bus pin and the V_{CC} supply rail of > 480k Ω (max) with a typical resistance > 2M Ω . The resistance between CANH and CANL of a powered-down transceiver has a typical resistance of 80k Ω .

Listen Mode

When a high level is applied to the RS pin, the device enters a low power listen mode. The driver of the transceiver is switched off to conserve power while the receiver remains active. In listen mode the transceiver draws 2mA (max) of current.

A low level on the RS pin brings the device back to normal operation.

Loopback Mode

When a high level is applied to the LBK pin, the device enters the loopback state. The transceiver CANH and CANL pins are disconnected from the bus. The driver and receiver circuitry of the transceiver remains active to allow for diagnostic testing of the node.

Using 3.3V Devices in 5V Systems

Looking at the differential voltage of both the 3.3V and 5V devices, the differential voltage is the same, the recessive common mode output is the same. The dominant common mode output voltage is slightly lower than the 5V counterparts. The receiver specs are also the same. Though the electrical parameters appear compatible it is advised that necessary system testing be performed to verify interchangeable operation.

Typical Performance Curves C_L = 15pF, T_A = +25°C; Unless Otherwise Specified.

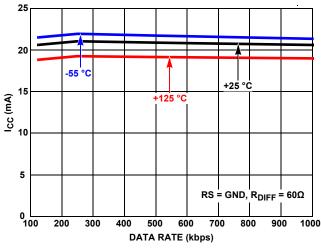
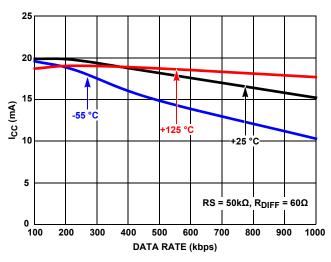
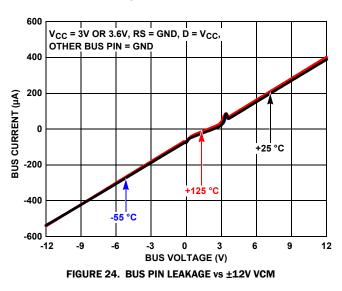


FIGURE 20. SUPPLY CURRENT vs FAST DATA RATE vs TEMPERATURE







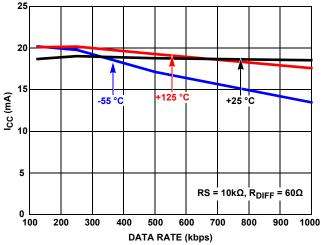
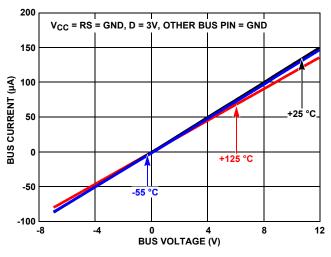
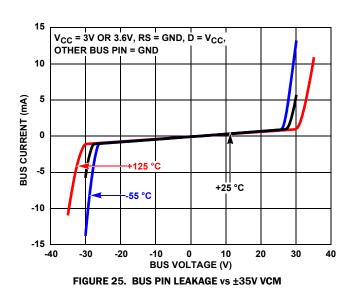


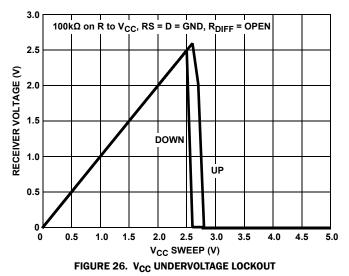
FIGURE 21. SUPPLY CURRENT vs MEDIUM DATA RATE vs TEMPERATURE







Typical Performance Curves $C_L = 15pF, T_A = +25°C$; Unless Otherwise Specified. (Continued)



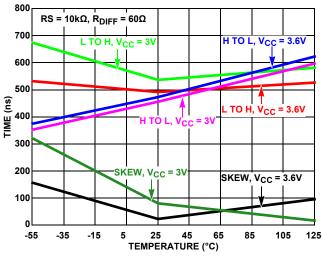


FIGURE 28. TRANSMITTER PROPAGATION DELAY AND SKEW vs TEMPERATURE AT MEDIUM SPEED

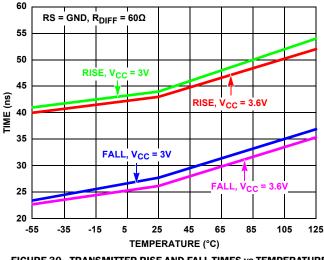


FIGURE 30. TRANSMITTER RISE AND FALL TIMES vs TEMPERATURE AT FAST SPEED

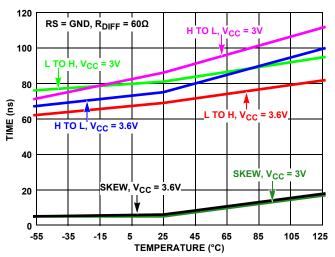


FIGURE 27. TRANSMITTER PROPAGATION DELAY AND SKEW vs TEMPERATURE AT FAST SPEED

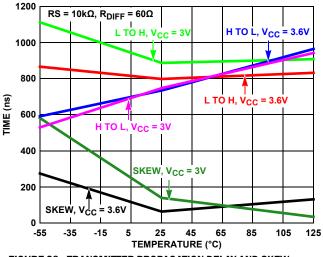
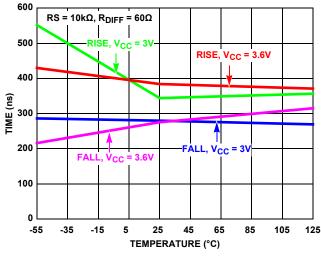
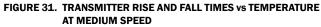
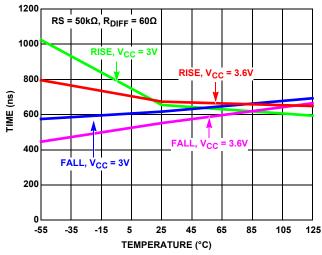


FIGURE 29. TRANSMITTER PROPAGATION DELAY AND SKEW vs TEMPERATURE AT SLOW SPEED





Typical Performance Curves $C_L = 15pF, T_A = +25°C$; Unless Otherwise Specified. (Continued)





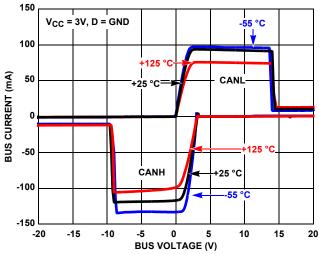
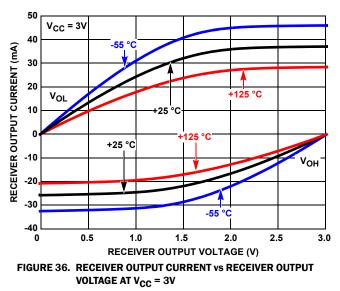


FIGURE 34. DRIVER OUTPUT CURRENT vs SHORT CIRCUIT VOLTAGE vs TEMPERATURE



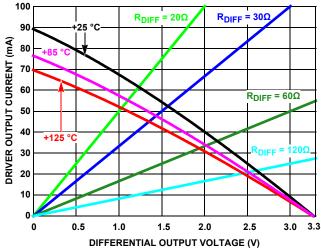
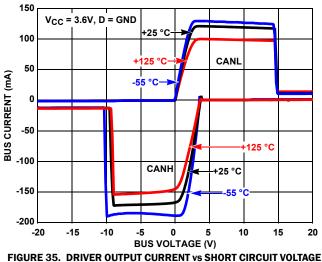
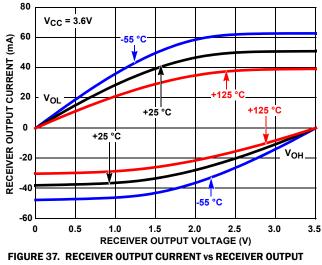


FIGURE 33. DRIVER OUTPUT CURRENT vs DIFFERENTIAL OUTPUT VOLTAGE

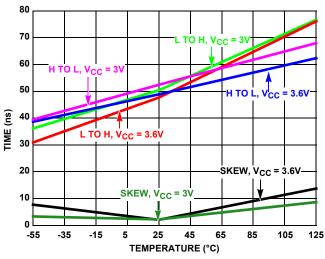


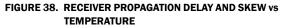
IGURE 35. DRIVER OUTPUT CURRENT vs SHORT CIRCUIT VOLTAGE vs TEMPERATURE

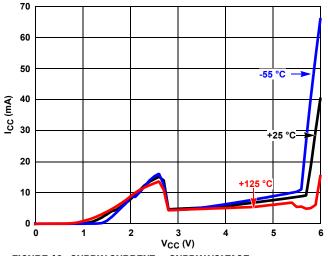


VOLTAGE AT V_{CC} = 3.6V

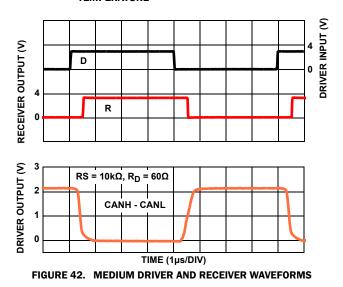
Typical Performance Curves $C_L = 15pF, T_A = +25°C$; Unless Otherwise Specified. (Continued)











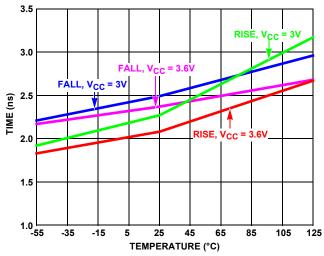
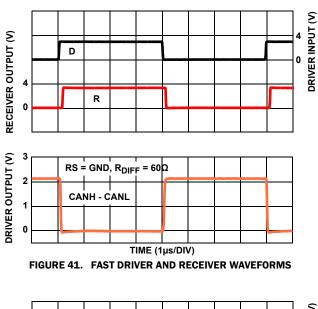


FIGURE 39. RECEIVER RISE AND FALL TIMES vs TEMPERATURE



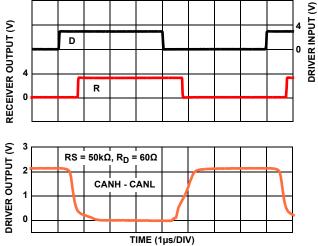


FIGURE 43. SLOW DRIVER AND RECEIVER WAVEFORMS

FN8762 Rev 3.00 August 16, 2016

intersil

Die Dimensions

2413µm x 3322µm (95 mils x 130.79 mils) Thickness: $305µm \pm 25µm (12 mils \pm 1 mil)$

Interface Materials

GLASSIVATION

Type: 12kÅ Silicon Nitride on 3kÅ Oxide

TOP METALLIZATION

Type: 300Å TiN on 2.8µm AlCu In Bondpads, TiN has been removed.

BACKSIDE FINISH

Silicon

PROCESS

P6SOI

Assembly Related Information

SUBSTRATE POTENTIAL

Floating

Additional Information

WORST CASE CURRENT DENSITY 1.6×10^{5} A/cm²

TRANSISTOR COUNT

4055

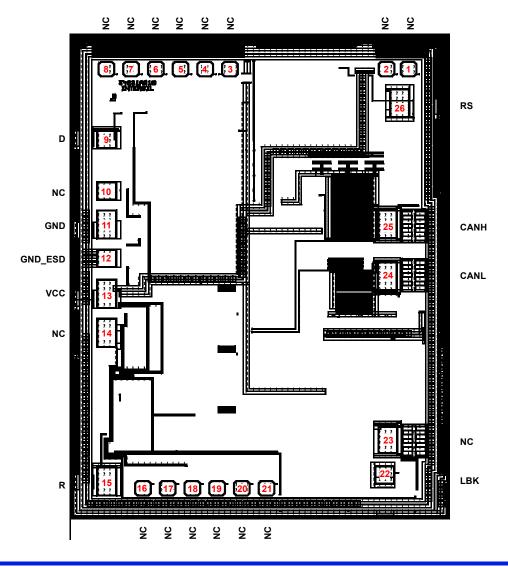
Weight of Packaged Device

0.31 grams

Lid Characteristics

Finish: Gold Potential: Grounded, tied to package pin 2

Metalization Mask Layout





		х	Y		
PAD NUMBER	PAD NAME	(μm)	(µm)	x	Y
1	NC	90.0	90.0	901.4	1365.6
2	NC	90.0	90.0	767.4	1365.6
3	NC	90.0	90.0	-183.23	1365.6
4	NC	90.0	90.0	-333.25	1365.6
5	NC	90.0	90.0	-483.25	1365.6
6	NC	90.0	90.0	-633.25	1365.6
7	NC	90.0	90.0	-783.25	1365.6
8	NC	90.0	90.0	-933.25	1365.6
9	D	110.0	110.0	-931.1	901.85
10	NC	110.0	110.0	-931.1	563.25
11	GND	110.0	180.0	-931.1	342.25
12	GND_ESD	110.0	110.05	-931.1	119.42
13	VCC	110.0	180.0	-931.1	-115.05
14	NC	110.0	180.05	-931.1	-371.08
15	R	110.0	180.0	-931.1	-1350.0
16	NC	90.0	90.0	-711.1	-1394.95
17	NC	90.0	90.0	-561.1	-1394.95
18	NC	90.0	90.0	-411.1	-1394.95
19	NC	90.0	90.0	-261.1	-1394.95
20	NC	90.0	90.0	-111.1	-1394.95
21	NC	90.0	90.0	38.9	-1394.95
22	LBK	110.0	110.0	756.9	-1307.3
23	NC	110.0	180.0	775.3	-1072.3
24	CANL	110.0	180.0	772.1	2.15
25	CANH	110.0	180.05	772.1	343.33
26	RS	110.0	180.0	848.1	1140.6

ISL72026SEH

NOTE: Origin of coordinates is the center of the die. NC - No Connect

FN8762 Rev 3.00 August 16, 2016

Revision History The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
August 16, 2016	FN8762.3	"Absolute Maximum Ratings" on page 4 changed voltage value in VCC to GND With/Without Ion Beam From: -0.3V to 4.5V To: -0.3V to 5.5V.
April 28, 2016	FN8762.2	 - Updated title. - Updated the test condition for Output Rise Time on page 6. - Changed maximum data rate from 1Mbps to 5Mbps in the following locations: - Second paragraph and "Features" section on page 1. - In "Overview" on page 10.
November 9, 2015	FN8762.1	Absolute Maximum Ratings table on page 4: changed the value for "CANH, CANL, VREF Under Ion Beam" from ±16V to ±18V.
October 26, 2015	FN8762.0	Initial Release

About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at <u>www.intersil.com</u>.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.

Reliability reports are also available from our website at www.intersil.com/support

© Copyright Intersil Americas LLC 2015-2016. All Rights Reserved. All trademarks and registered trademarks are the property of their respective owners.

For additional products, see www.intersil.com/en/products.html

Intersil products are manufactured, assembled and tested utilizing ISO9001 quality systems as noted in the quality certifications found at www.intersil.com/en/support/qualandreliability.html

Intersil products are sold by description only. Intersil may modify the circuit design and/or specifications of products at any time without notice, provided that such modification does not, in Intersil's sole judgment, affect the form, fit or function of the product. Accordingly, the reader is cautioned to verify that datasheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

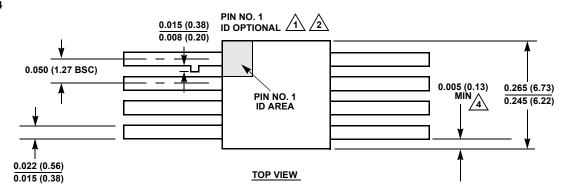


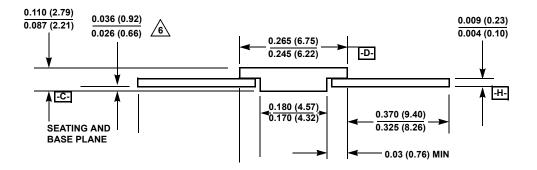
Package Outline Drawing

K8.A

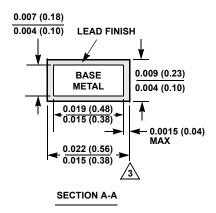
8 LEAD CERAMIC METAL SEAL FLATPACK PACKAGE

Rev 4, 12/14





SIDE VIEW



NOTES:

- ✓1. Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark. Alternately, a tab may be used to identify pin one.
- $\frac{2}{2}$ If a pin one identification mark is used in addition to or instead of a tab, the limits of the tab dimension do not apply.
- 7. The maximum limits of lead dimensions (section A-A) shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
- 4. Measure dimension at all four corners.
- 5. For bottom-brazed lead packages, no organic or polymeric materials shall be molded to the bottom of the package to cover the leads.
- Dimension shall be measured at the point of exit (beyond the meniscus) of the lead from the body. Dimension minimum shall be reduced by 0.0015 inch (0.038mm) maximum when solder dip lead finish is applied.
- 7. Dimensioning and tolerancing per ANSI Y14.5M 1982.
- 8. Controlling dimension: INCH.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Renesas manufacturer:

Other Similar products are found below :

EL4511CUZ-T7 PYB15-Q24-S5-H-U PQA30-D24-S24-DH PQA30-D48-S12-TH PYB30-Q24-T312-H-U PYB15-Q24-S5-H-T PYB15-Q24-S12-H-T V7815-500-SMT PYB20-Q48-S12-H-T PQZ6-Q24-S15-D PYB20-Q48-S5-H-T PYB20-Q24-S12-H-T VLED15-120-350 VGS-75-12 PYB15-Q24-S12-H-U R5F100GFAFB#V0 VGS-50-15 VGS-50-24 VGS-25-24 VGS-50-5 VGS-100-12 M30620FCAFP#U3 PDQ2-D24-S12-S PDS1-S12-D12-M PDS1-S12-D15-M PYB15-Q24-S12-T PYB20-Q48-S12 R0K33062PS000BE R0K505220S000BE R0K561664S000BE R0K570865S000BE HC55185AIMZ R7S721001VCBGAC0 EMMA050200-P5P-IC EPSA050250UB-P5P-EJ HS0005PUU01H IS82C55A-5 ISL55110IVZ ISL6730AEVAL1Z ISL68200DEM01Z ISL78235EVAL2Z ISL78268EVAL1Z ISL91107IRA-EVZ ISL9220IRTZEVAL1Z ISLUSBI2CKIT1Z RTK5RX2310P00000ZR SDI120-12-U-P51 PEM1-S24-D12-S PQA30-D24-S24-T PQA30-D48-S24-T